



040804

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: Gurtej S. Sandhu et al.

Title: METHOD FOR FORMING A METALLIZATION LAYER

Attorney Docket No.: 303.085US7

Customer No.: 21186

17513 U.S. PTO
10/820291

040804

PATENT APPLICATION TRANSMITTAL**MAIL STOP PATENT APPLICATION**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the following attached items and information (as indicated with an "X"):

- ☒ Return postcard.
- ☒ **DIVISIONAL** of prior Patent Application No. (10/217618) (under 37 CFR 1.53(b)) comprising:
- ☒ Specification (13 pgs, including claims numbered 1 through 32 and a 1 page Abstract).
- ☒ Formal Drawing(s) (2 sheets).
- ☒ Copy of signed Combined Declaration and Power of Attorney (7 pgs) from prior application.
- ☒ Incorporation by Reference: *The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied herewith, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein.*
- ☒ Check in the amount of \$1330.00 to pay the filing fee.
- ☒ Prior application is assigned of record to Micron Technology, Inc.
- ☒ Information Disclosure Statement (2 pgs), Form 1449 (1 pgs)
- References NOT enclosed, cited in prior application.
- ☒ A Communication Concerning Related Applications (1 pg.).

The filing fee has been calculated below as follows:

	No. Filed	No. Extra	Rate	Fee
TOTAL CLAIMS	32-20	12	x 18.00 =	\$216.00
INDEPENDENT CLAIMS	7-3	4	x 86.00 =	\$344.00
[] MULTIPLE DEPENDENT CLAIMS PRESENTED				\$0.00
BASIC FEE				\$770.00
TOTAL				\$1330.00

Please charge any additional required fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

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"Express Mail" mailing label number: EV299683351US

Date of Deposit: April 8, 2004

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S/N Unknown

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Gurtej S. Sandhu et al. Examiner: Unknown
Serial No.: Unknown Group Art Unit: Unknown
Filed: Herewith Docket: 303.085US7
Title: METHOD FOR FORMING A METALLIZATION LAYER

COMMUNICATION CONCERNING RELATED APPLICATION(S)

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Applicants would like to bring to the Examiner's attention the following related application(s) in the above-identified patent application:

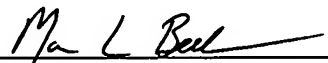
<u>Serial/Patent No.</u>	<u>Filing Date</u>	<u>Attorney Docket</u>	<u>Title</u>
09/517684 6171952	March 2, 2000	303.085US3	METHODS OF FORMING METALLIZATION LAYERS AND INTEGRATED CIRCUITS CONTAINING SUCH
10/217618	August 13, 2002	303.085US6	METHOD FOR FORMING A METALLIZATION LAYER

Respectfully submitted,

GURTEJ S. SANDHU ET AL.

By Applicants' Representatives,

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